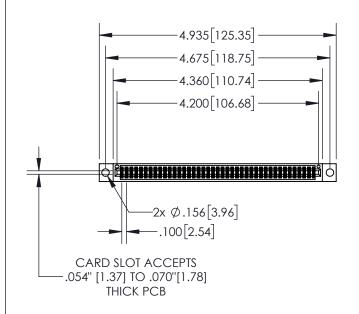
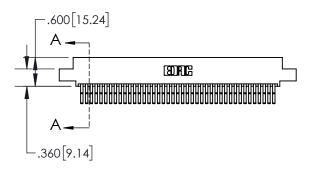
## **Contact Dimensions:**

560-Extender Board Bend (Code 523 Contacts) See Sheet 2 for Contact Code 555, 556, 558, 559, 560 Dimensions





- INSULATOR MATERIAL: THERMOPLASTIC, UL 94V-0
- CONTACT MATERIAL; COPPER TIN ALLOY CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE



1

.330[8.38] CARD SLOT					
370[9.40] SECTION A-A					
.160[4.06] POINT OF CONTACT					

845/895 SEI	RIES HIGH TEMF	CARD	EDGE	CONNECT	OR
PART NUME	BFR: 845-082-56	0-504			



ACAD REFERENCE NO	. 845-ENG-MASTER
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CHECKED:	DATE:
SCALE: 1:2	SHEET 1 OF 2
DRAWING NUMBER	ISSUE

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- INSULATOR MATERIAL: THERMOPLASTIC POLYESTER, UL 94V-0 DAP MATERIAL AVAILABLE UPON REQUEST
- CONTACT MATERIAL; COPPER ALLOY

CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

## 845/895 SERIES HIGH TEMP CARD EDGE CONNECTOR CONTACT CODE 555,556,558,559,560 DIMENSIONS

YOUR CONNECTION TO QUALITY & SERVICE

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	CHECKED:	DATE:
	SCALE: 1:1	SHEET 2 OF 2
D	DRAWING NUMBER	ISSUE

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